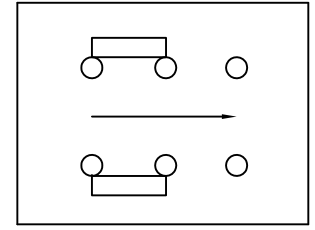
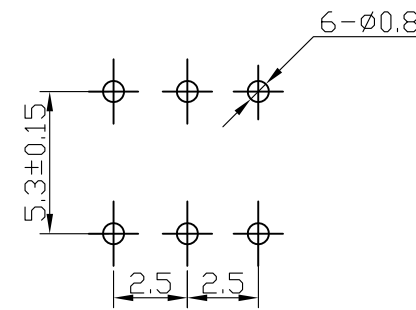
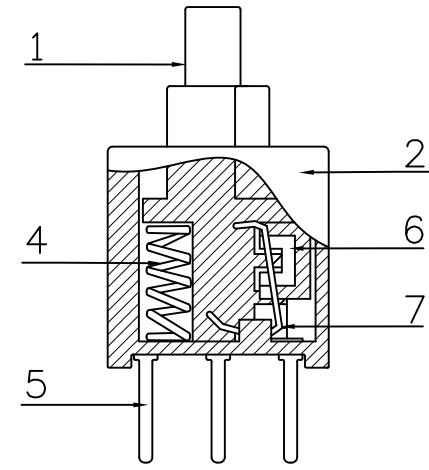
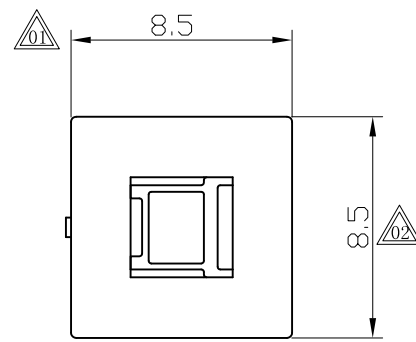


成品检验图纸



PCB Layout

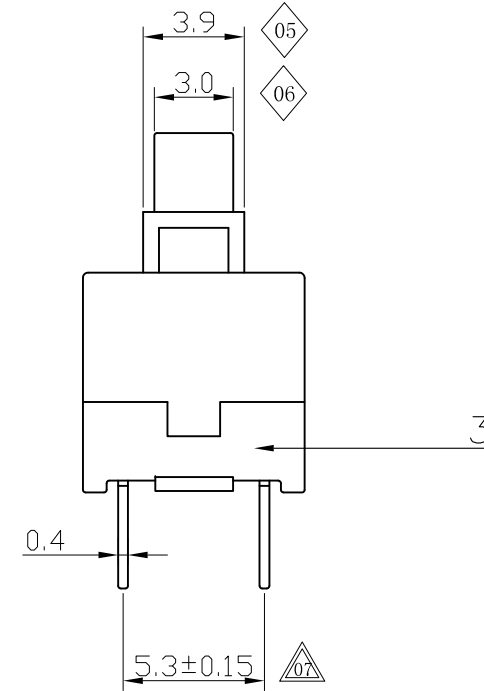
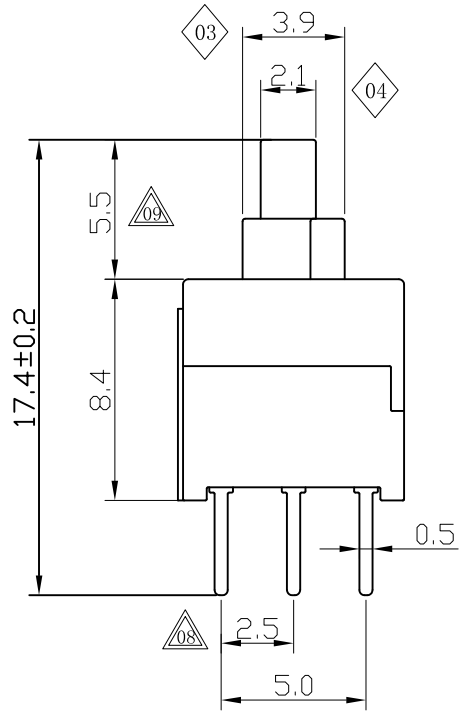
Circuit Diagram

备注:

- 1. 额定值: 直流30伏 0.1安
- 2. 接触电阻: 100毫欧 最大
- 3. 绝缘阻抗: 100兆欧 最小(直流250伏)
- 4. 耐高压: 交流250伏 (50-60赫兹) 持续 1 分钟
- 5. 操作力: 240±50gf
- 6. 寿命测试:10万次
- 7. 操作全行程: 2.40±0.2mm

备注:

◇: 表示重点管控尺寸, 一般为功能尺寸, 首检及巡检时需量测。
△: 表示次重点管控尺寸, 一般为装配尺寸, 首检时需量测。
1) 重点及次重点管控尺寸中的序号不可重复, 需依次往后增加。若其中有某个尺寸在变更或其它状况下, 尺寸消失或不要求管控时, 原序号不可再用。有其它尺寸需要增加管控时, 序号往后增加。
2) 版次定义: 新开发而未转量产之产品图面版次为A1, A2, A3...
已转量产之产品图面版次为A, B, C...



①	导 芯		1	POM	白色	UL94HB
②	盖 子		1	POM	灰色	UL94HB
③	基 座		1	PBT	黑色	UL94HB
④	弹 簧		1	不锈钢		
⑤	端 子		6	黄铜	镀银	
⑥	簧 片		2	磷铜		
⑦	钩 针		1	碳素钢		

序号	零件	端子编号	用量	材料	镀层/颜色	备注		
承认			日期	 Kaihlh	东莞市凯华电子有限公司 KAIHUA ELECTRONICS CO.,LTD			
设计	吴宇	2018.10.10						
审核				名称	8.5自锁6PIN按键开关			
核准				料号	CPG858410D08			
未注尺寸公差		30<L	±0.30	角度	单位: mm	比例	:1	视角 
		10<L≤30	±0.20					
		5<L≤10	±0.15					
		L≤5	±0.10					
		±2°						
				图号	页次 1 Of 1			

A

A

工程变更单号	版次	日期	说明	修改	审核	核准
	A		NEW			

4

3

2

1



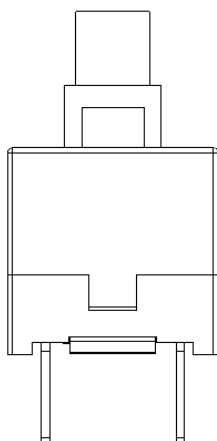
凱華電子
KAIHUA EEELETRONICS

Document Number:

KH-PS1808-13

产品规格书

Product Specification



P/N: _____

CPG858410D08

Title :

Push Button Switch

Rev.	ECN	Release and Revision Description:	PreparedBy/Date:	Checked By/Date:	Approved By/Date:
A	-----	New releasing 初版发行	吴宇 2018.08.23	吕攀豪 2018.08.23	王锋 2018.08.23



凱華電子
KAIHUA EEELECTRONICS

Product Specification

P/N:

CPG858410D08

DOC. No.:

KH-PS1808-13

Rev.:

A

Page:

2/10

Content

目录

1. Scope/范围:	3
2. Product Application/产品应用:	3
3. Technology Parameters/技术参数	3
4. Ratings/额定性能要求	3
5. Profile Dimensions /外形尺寸	3
6. Electrical Performance/电气性能	4
7. Mechanical Performance/机械性能	5
8. Environmental Performance/环境性能	7
9. Recommended PCB Layout/推荐的 PCB 安装焊盘规格	9
10. Packaging 包装:	9
11. Precaution/注意事项	10

“ Confidential ”

All Right Reserved COPYRIGHT Kaihua Electronics Co.,LTD



凱華電子
KAIHUA EEELETRONICS

Product Specification

P/N:	DOC. No.:	Rev.:	Page:
CPG858410D08	KH-PS1808-13	A	3/10

1. Scope/范围:

This Product Specification covers the requirement of Push button switch on product performance, test methods and quality assurance provisions.
本规格书内容涵盖按键开关产品的要求，包括性能指标、测试方法及质量保证方面等。

2. Product Application/产品应用:

The Switch is applied in all types of Computer. Please let us know before using any of the products in the application not described above.
该开关产品适用于所有类型的家用电器，如果用于本文中未提及的领域请在使用前告知。

3. Technology Parameters/技术参数

Ambient Humidity 工作湿度:	45~85% R.H.;
Operating Temperature Range 使用温度范围:	-10℃~+70℃;
Storage Temperature Range 保存温度范围:	-20℃~+70℃;
Normal Condition:	
Ambient temperature 环境温度:	20±5℃
Relative humidity 相对湿度:	65%±5% R.H.;
Air pressure 气压:	86~101KPa;
Contact Resistance 接触阻抗:	100 mΩ Max;
Operation Force 操作力:	240±50gf;
Solder Ability 可焊性:	260±5℃, 3±0.5s;
Withstand Soldering Temperature 耐焊接热:	260±5℃, 3±0.5s;

4. Ratings/额定性能要求

Rating 额定负荷:	DC30V / 0.1A;
InsulationResistance 绝缘电阻:	≥100MΩ/DC 250V;
Withstand Voltage 耐电压:	250V AC 1 Minute;
Mechanical Life 机械寿命:	100,000 Cycles.

5. Profile Dimensions /外形尺寸

见成品图

“ Confidential ”

All Right Reserved COPYRIGHT Kaihua Electronics Co.,LTD



6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍, 施加在手柄中心. Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA) 在低电流 (≤100mA) 条件下测试. Measured at low current (100mA or less).	100mΩ Max 100mΩ 以下
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 250 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 250V DC 电压 1 分钟, 按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上
6.3	Dielectric withstanding voltage 耐电压	Apply a Voltage of AC 250 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 250V AC 电压 1 分钟, 按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	No evidence of breakdown 无瞬断、击穿等破坏.
6.4	Bouncing 触点抖动	Operation speed: 1~2 times/s 操作速度: 每秒 1~2 次 Slightly push the center of stem by 1~2 times/s, to test the bounce at "ON" and "OFF" 以每秒 1~2 次的速度, 轻轻在手柄中心加力, 在"导通"与"瞬断"间测试. Oscillo scope 示波器 Switch Bouncing Test Circuit 抖动测定回路.	Before Life cycle: On:10ms MAX,10 毫秒以下 Off: 10ms MAX,10 毫秒以下 After Life cycle: On:15ms MAX,15 毫秒以下 Off: 15ms MAX,15 毫秒以下



凱華電子
KAIHUA EEELETRONICS

Product Specification

P/N:

CPG858410D08

DOC. No.:

KH-PS1808-13

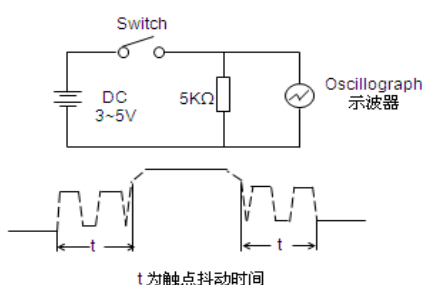
Rev.:

A

Page:

5/10

触点抖动用图：



7. Mechanical Performance/机械性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求
7.1	Operation force 操作力	Operate the keystroke of the switch and then increase press strength gradually, Measured maximum operation force while the travel of the switch is full. 逐渐施力操作开关按键，测量开关到达全部工作行程时所需的最大操作力度。	240±50gf
7.2	Travel 行程	Operate the keystroke of the switch vertically, the travel distance of keystroke moving from its free position to maximum moving distance shall be measurement. 垂直操作开关按键，量测开关顶端最大移动距离。	Full travel: 全行程 2.4±0.20mm

“ Confidential ”

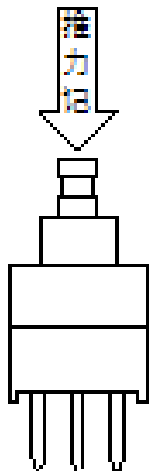
All Right Reserved COPYRIGHT Kaihua Electronics Co.,LTD



7.3

Static
Strength
静止强度

A static load of 1 Kgf shall be applied in the direction of button operation for a period of 60 seconds.
在手柄动作方向施加 1kgf 的静负荷 60 秒, 然后测试参数.



No damage (Electrical And mechanical)
电气和机械性能正常.

7.4

Stem Pull
Strength
手柄拉拔强度

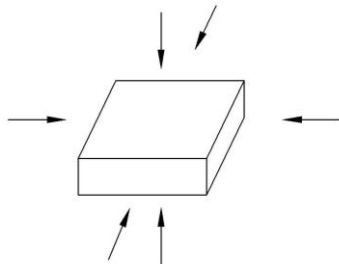
Break by a pull force applied opposite to the direction of stem operation.
在推柄动作方向反向垂直施加拉力, 使其破坏的程度.

500gf Min

7.5

Shock
机械冲击

Measured by according to the below condition:
(1) Acceleration: 80g 加速度
(2) Cycles of test: 3 cycles each in 6 directions, for a total of 18 cycles.
试验次数: 每个方向 3 次, 6 个方向共 18 次.



Shall meet No.6, 7.1, 7.2.
满足 6, 7.1, 7.2 要求.



7.6	Life Test 寿命测试	(1) Weight:500gf 砵碼: 500gf (2) Operation speed: 1cycles/s 操作速度: 1 次/秒 (3) Push force: Maximum value of operation force. 按压力: 操作力规格值的上限. (4) Cycles: 100,000 times Min 操作次数: 10 万次以上	Contact resistance: 10000 mΩ Max 接触电阻: 10000 毫欧以 下 Bouncing: 15ms Max 触点抖动: 15 毫秒以下 Operation force: Variation rate within ±30% 操作力的变化范围在初始 值的±30%以内.
-----	-------------------	---	--

8.Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求												
8.1	Cold test 耐寒性	(1) Temperature : - 20±2℃ 温度： - 20±2℃ (2) Duration of test: 96h 持续时间： 96 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test : 1h 试验后的放置条件： 1 小时	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω 以下 满足： No. 6.2 to 6.4 No. 7.1 to 7.2												
8.2	Heat test 耐热性	(1) Temperature : 80±2℃ 温度： 80±2℃ (2) Duration of test: 96h 持续时间： 96 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test : 1h 试验后的放置条件： 1 小时	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω 以下 满足： No. 6.2 to 6.4 No. 7.1 to 7.2												
8.3	Temperature cycle 温度循环	(1) Test cycles: 5 cycles 试验周期： 5 个周期 (2) Standard condition after test:1h 试验后的放置条件： 1 小时 <table><tr><td></td><td>Temperature 温度</td><td>Duration of test 持续时间</td></tr><tr><td rowspan="4">1 cycle 一次循环</td><td>20±5℃</td><td>1h</td></tr><tr><td>-20±2℃</td><td>1h</td></tr><tr><td>20±5℃</td><td>1h</td></tr><tr><td>80±5℃</td><td>1h</td></tr></table>		Temperature 温度	Duration of test 持续时间	1 cycle 一次循环	20±5℃	1h	-20±2℃	1h	20±5℃	1h	80±5℃	1h	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2 接触电阻 200m Ω 以下 满足： No. 6.2 to 6.4 No. 7.1 to 7.2
	Temperature 温度	Duration of test 持续时间													
1 cycle 一次循环	20±5℃	1h													
	-20±2℃	1h													
	20±5℃	1h													
	80±5℃	1h													



8.4

Soldering
heat test
耐焊接热

Soldering area: T/2 of PCB thickness.
(PCB: T=1.6mm)

焊接面积: 印刷基板的 1/2 厚度处

Soldering temperature: $260 \pm 5^{\circ}\text{C}$

Soldering time: $3 \pm 0.5\text{s}$

焊接温度: $260 \pm 5^{\circ}\text{C}$

焊接时间: 3 ± 0.5 秒

Appearance:
No abnormality.
外观无异常

8.5

Solderability
可焊性

1. Hand soldering 手工焊接:

Please practice according to below
condition:

(1) Soldering Temperature : $350 \pm 5^{\circ}\text{C}$

焊接温度: $350 \pm 5^{\circ}\text{C}$

(2) Continual soldering time: $3 \pm 0.5\text{s}$

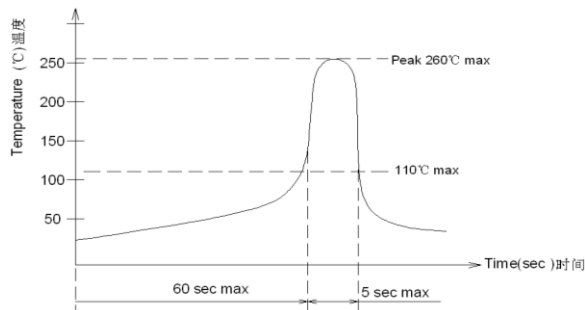
连续焊接时间: 3 ± 0.5 秒

(3) Capacity of soldering iron: $\leq 20\text{w}$

电烙铁功率: 20 瓦以下

2. Automatic PIP soldering 自动焊接:

For the product of T/H, according to below
condition:



At least 95% of surface
area of immersed
portion shall be covered
by solder.
侵焊面积大于 95%以上.

8.6

Humidity
test
耐湿性

(1) Temperature : $40 \pm 2^{\circ}\text{C}$

温度: $40 \pm 2^{\circ}\text{C}$

(2) relative humidity: 90~95% R.H.

相对湿度: 90~95% R.H.

(3) Duration of test: 96h

持续时间: 96 小时

(4) Take off a drop water

去掉水珠

(5) Standard conditions after test: 1h

试验后的放置条件: 1 小时

Contact resistance:
 $200\text{m}\Omega$ Max
Shall meet :
No. 6.2 to 6.4
No. 7.1 to 7.2
接触电阻 $200\text{m}\Omega$ 以下
满足:
No. 6.2 to 6.4
No. 7.1 to 7.2



凱華電子
KAIHUA EEELETRONICS

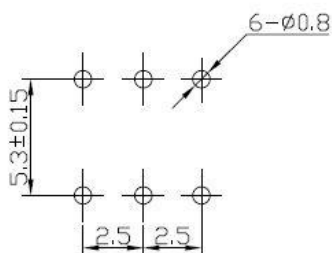
Product Specification

P/N:	DOC. No.:	Rev.:	Page:
CPG858410D08	KH-PS1808-13	A	9/10

8.7	Salt Spray 盐雾测试	Apply the following environment to test: 根据下列条件进行测试: (1) Temperature : $35 \pm 5^{\circ}\text{C}$ 温度: $35 \pm 5^{\circ}\text{C}$; (2) Salt water density: $5 \pm 1\%$ 盐水浓度: $5 \pm 1\%$; (3) Duration: 24 hours 持续时间: 24 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材. Contact Resistance: 200 m Ω Max 接触电阻: 200 毫欧以下
8.8	Withstand K ₂ S 硫化测试	Apply the following environment to test: 根据下列条件进行测试 (1) Temperature: $35 \pm 5^{\circ}\text{C}$ 温度: $35 \pm 5^{\circ}\text{C}$ (2) K ₂ S Density: 2%; 硫化钾浓度: 2% (3) Duration: 2 minute. 持续时间: 2 分钟	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材. Contact Resistance: 200 m Ω Max 接触电阻: 200 毫欧以下

9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

(Top View)



PCB Layout

10. Packaging 包装

Packaging type: PE Bag, 1000Pcs/Bag, 5000Pcs/Inner Carton. 20000Pcs/Outer Carton.

包装方式: PE 袋, 1000Pcs/袋. 5000Pcs/内箱. 20000Pcs/外箱

“ Confidential ”

All Right Reserved COPYRIGHT Kaihua Electronics Co.,LTD



凱華電子
KAIHUA EEELETRONICS

Product Specification

P/N:

CPG858410D08

DOC. No.:

KH-PS1808-13

Rev.:

A

Page:

10/10



11. Precaution 注意事项

11.1 Immersion Soldering condition 浸焊条件

ITEM 项目	CONDITION 条件
Preheat temperature 预热温度	110°C Max (Ambient temperature of soldering surface of P.W.B) 110°C 以下(印刷基板焊锡面周围的温度)
Preheat time 预热时间	60s, Max 60 秒以内
Area of flux 助焊剂面积	1/2 Max of PWB Thickness 印刷基板厚度的 1/2 以内
Temperature of solder 焊锡温度	260±5°C 260±5°C
Time of immersion 浸焊时间	Within 3s 3 秒以内
Number of soldering 焊接次数	2time Max (But should down heat of the first soldering) 2 次以内
Printed wiring board 印刷基板	Single side copper-clad laminates 单面铜箔

(1) After switches were soldered, please be careful not to clean switches with solvent

开关浸焊后,注意不要用溶剂清洗.

(2) Under the condition of using soldering iron, soldering temperature shall be 350°C max within 3 sec.

在使用烙铁的情况下,焊锡温度应在350°C以下,焊接时间3秒以内.

11.2 Notes 注意点

(1) Please be cautious not to give excessive static load or shock to switches.

注意不要施加超负荷的压力或晃动开关.

(2) Please be careful not to stack up P. W. B. after switches were soldered.

开关焊接以后,印刷基板注意不要叠放.

(3) Preservation under high temperature and high humidity or corrosive gas should be avoided

Especially. When you need to preserve for a long period, do not open the carton.

保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.

(4) Products meet the ROHS & REACH environmental management substances control standards

产品满足 ROHS & REACH 环境管理物质管制标准

“ Confidential ”

All Right Reserved COPYRIGHT Kaihua Electronics Co.,LTD